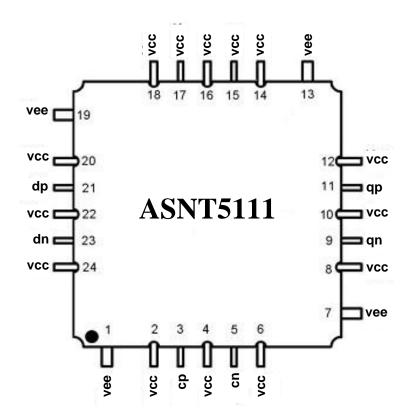
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ASNT5111-KMC DC-50Gbps D-Type Flip-Flop

- High speed broadband D-Type Flip-Flop for data retiming with full rate clock
- Exhibits low jitter and limited temperature variation over industrial temperature range
- 3ps set-up/hold time capability
- 88% clock phase margin for retiming of data input eye
- Fully differential CML input interfaces
- Fully differential CML output interface with 400mV single-ended swing
- Single +4.0V or -4.0V power supply
- Power consumption: 520mW
- Fabricated in SiGe for high performance, yield, and reliability
- Custom CQFP 24-pin package



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DESCRIPTION

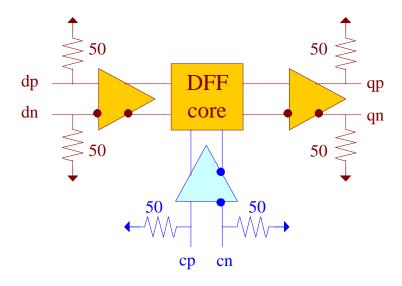


Fig. 1. Functional Block Diagram

The temperature stable ASNT5111-KMC SiGe IC provides broadband data retiming functionality and is intended for use in high-speed measurement / test equipment. The IC shown in Fig. 1 can sample a high-speed data signal dp/dn with a full-rate external clock cp/cn to create a full-rate retimed NRZ data output qp/qn.

The part's I/O's support the CML logic interface with on chip 50*Ohm* termination to vcc and may be used differentially, AC/DC coupled, single-ended, or in any combination (see also POWER SUPPLY CONFIGURATION). In the DC-coupling mode, the input signal's common mode voltage should comply with the specifications shown in ELECTRICAL CHARACTERISTICS. In the AC-coupling mode, the input termination provides the required common mode voltage automatically. The differential DC signaling mode is recommended for optimal performance.

POWER SUPPLY CONFIGURATION

The part can operate with either a negative supply (vcc = 0.0V = ground and vee = -4.0V), or a positive supply (vcc = +4.0V and vee = 0.0V = ground). In case of a positive supply, all I/Os need AC termination when connected to any devices with 50Ohm termination to ground. Different PCB layouts will be needed for each different power supply combination.

All the characteristics detailed below assume vcc = 0.0V and vee = -4.0V.



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ABSOLUTE MAXIMUM RATINGS

Caution: Exceeding the absolute maximum ratings shown in Table 1 may cause damage to this product and/or lead to reduced reliability. Functional performance is specified over the recommended operating conditions for power supply and temperature only. AC and DC device characteristics at or beyond the absolute maximum ratings are not assumed or implied. All min and max voltage limits are referenced to ground (assumed VCC).

Table 1. Absolute Maximum Ratings

Parameter	Min	Max	Units
Supply Voltage (vee)		-4.4	V
Power Consumption		0.58	W
RF Input Voltage Swing (SE)		1.0	V
Case Temperature		+90	${}^{o}\!C$
Storage Temperature	-40	+100	°C
Operational Humidity	10	98	%
Storage Humidity	10	98	%

TERMINAL FUNCTIONS

TERMINAL		A L	DESCRIPTION				
Name	No.	Type					
High-Speed I/Os							
dp	21	CML	Differential high-speed data inputs with internal SE 500hm				
dn	23	input	termination to VCC				
ср	3	CML	Differential high-speed clock inputs with internal SE 500hm				
ср	5	input	termination to VCC				
qp	11	CML	Differential high-speed data outputs with internal SE 500hm				
qn	9	output	termination to vcc. Require external SE 50 <i>Ohm</i> termination to vcc				
	Supply and Termination Voltages						
Name		Descript	ion Pin Number				
vcc	Positive power supply		er supply 2, 4, 6, 8, 10, 12, 14, 15, 16, 17, 18, 20, 22, 24				
	(+4.0V or 0)		r 0)				
vee	Negative power supply (0V		supply (0V 1, 7, 13, 19				
	or -4.0 <i>V</i>)		V)				



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ELECTRICAL CHARACTERISTICS

PARAMETER	MIN	TYP	MAX	UNIT	COMMENTS			
General Parameters								
vee	-3.8	-4.0	-4.2	V	±6%			
VCC		0.0		V	External ground			
<i>I</i> vee		130		mΑ				
Power consumption		520		mW				
Junction temperature	-40	25	125	$^{\circ}C$				
HS Input Data (dp/dn)								
Data Rate	DC		50	Gbps				
Swing	0.05		0.8	V	Differential or SE, p-p			
CM Voltage Level	vcc-0.8		VCC	V	Must match for both inputs			
HS Input Clock (cp/cn)								
Frequency	DC		50	GHz				
Swing	0.05		0.8	V	Differential or SE, p-p			
CM Voltage Level	vcc-0.8		VCC	V	Must match for both inputs			
Clock Phase Margin	86	88	90	%				
	HS Output Data (qp/qn)							
Data Rate	DC		50	Gbps				
Logic "1" level	VCC		\overline{V}					
Logic "0" level	,	vcc-0.4		V	With external 50 <i>Ohm</i> DC termination			
Rise/Fall times			10	ps	20%-80%			
Output Jitter			2.5	ps	Peak-to-peak			

PACKAGE INFORMATION

The chip die is housed in a custom 24-pin CQFP package shown in Fig. 2. The package provides a center heat slug located on its back side to be used for heat dissipation. ADSANTEC recommends for this section to be soldered to the **vcc** plain, which is ground for a negative supply, or power for a positive supply.

The part's identification label is ASNT5111-KMC. The first 8 characters of the name before the dash identify the bare die including general circuit family, fabrication technology, specific circuit type, and part version while the 3 characters after the dash represent the package's manufacturer, type, and pin out count.

This device complies with the Restriction of Hazardous Substances (RoHS) per 2011/65/EU for all ten substances.

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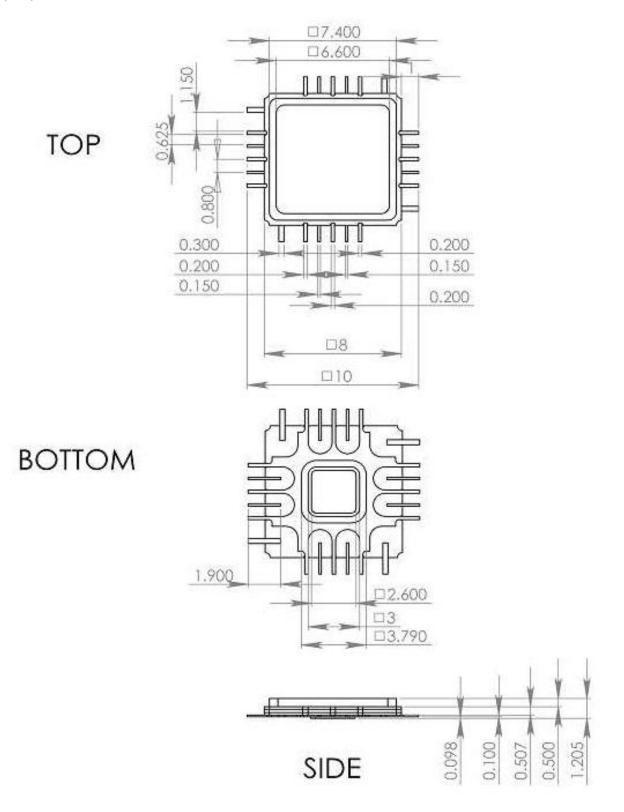


Fig. 2. CQFP 24-Pin Package Drawing (All Dimensions in mm)



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REVISION HISTORY

Revision	Date	Changes			
2.2.2	02-2020	Updated Package Information			
2.1.2	07-2019	Updated Letterhead			
2.1.1	12-2016	Revised features			
		Revised power supply configuration			
		Revised absolute maximum ratings			
		Revised electrical characteristics			
		Revised package information			
2.0.1	02-2013	Revised title			
		Added package pin out drawing			
		Revised functional block diagram			
		Revised description			
		Added power supply configuration			
		Added absolute maximum ratings			
		Revised terminal functions			
		Revised electrical characteristics			
		Added package information and mechanical drawing			
		Format correction			
1.0	02-2008	First release			